



# VK36N4I Datasheet

4-channel touch I2C output

Rev.1.2

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## 1 General Description

VK36N4I is a 4-channel touch detection chip designed to detect touch actions on external capacitive keys. With high integration, it requires only minimal external components to implement touch detection.

The chip supports I2C communication, includes one INT interrupt output pin, and allows selection of the active output level via an IO pin. Its internal specialized circuit design provides a high power supply rejection ratio, effectively preventing false triggering and ensuring high reliability even in challenging environments.

Equipped with features such as auto-calibration, low standby current, and voltage fluctuation resistance, the chip offers a simple and efficient solution for applications requiring touch keys with I2C output.

## 2 Key Features

- Operating voltage: 2.2-5.5V
- Standby current 10 $\mu$ A/3.0V
- Power-on reset function (POR)
- Low-voltage reset function (LVR)
- Touch output response time: 48ms in operating mode, 160ms in standby mode
- Output active-high or active-low configurable via the AHLB pin on power-up
- I2C output with INT interrupt pin
- Supports multi-key simultaneous touch detection
- Anti - misoperation function: maximum valid key output duration is 13 seconds
- Enters standby mode if no touch is detected for 4 seconds
- Overall sensitivity adjustable via a capacitor connected to the CS pin (1–47nF)
- Individual touch channel sensitivity fine-tunable with a small capacitor to ground (0–50pF)
- 0.3-second stabilization period after power-up; touch detection is disabled during this interval
- Automatic baseline calibration when no touch is detected after power-up
- Excellent voltage fluctuation tolerance and strong anti-interference performance
- Available Packages:
  - SOP16(150mil)(9.9mm x 3.9mm PP=1.27mm)
  - QFN16L(3.0mm x 3.0mm PP=0.5mm)

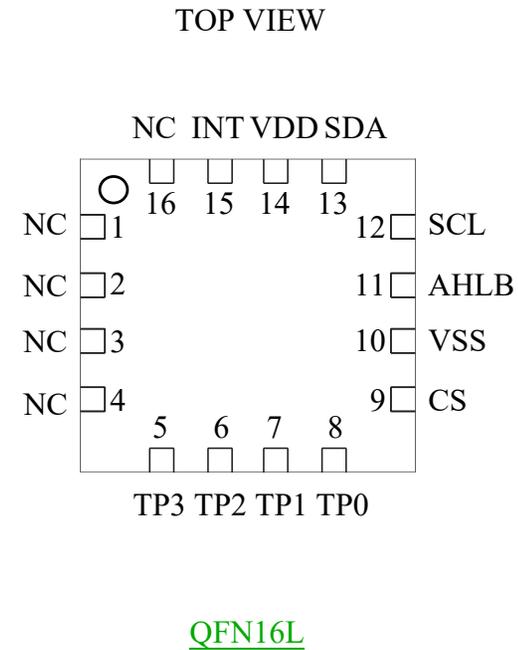
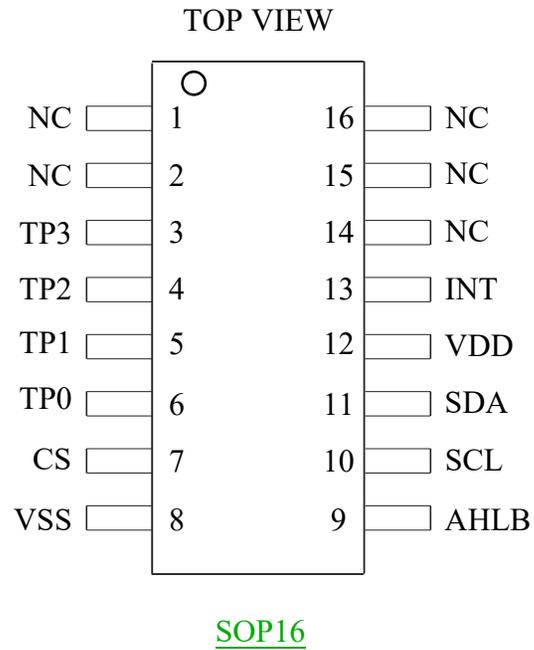
### 3 Product Selection

Part No.	Voltage/Standby Current	Output	Packaging
VK36N4I	2.2V-5.5V/10 $\mu$ A(3V)	I2C Output	SOP16/QFN16L
VK36N5I	2.2V-5.5V/10 $\mu$ A(3V)	I2C Output	SOP16/QFN16L
VK36N6I	2.2V-5.5V/10 $\mu$ A(3V)	I2C Output	SOP16/QFN16L
VK36N7I	2.2V-5.5V/10 $\mu$ A(3V)	I2C Output	SOP16/QFN16L
VK36N8I	2.2V-5.5V/10 $\mu$ A(3V)	I2C Output	SOP16/QFN16L
VK36N9I	2.2V-5.5V/10 $\mu$ A(3V)	I2C Output	SOP16/QFN16L
VK36N10I	2.2V-5.5V/10 $\mu$ A(3V)	I2C Output	SOP16/QFN16L

### 4 Ordering Information

Part No.	Packaging	Tube Qty	Tray(reel)Qty	Box Qty	Total Qty	Notes
VK36N4I	SOP16	50/tube		5000/box	50000 PCS	
	QFN16L		3000/reel	30000/box	120000 PCS	
VK36N5I	SOP16	50/tube		5000/box	50000 PCS	
	QFN16L		3000/reel	30000/box	120000 PCS	
VK36N6I	SOP16	50/tube		5000/box	50000 PCS	
	QFN16L		3000/reel	30000/box	120000 PCS	
VK36N7I	SOP16	50/tube		5000/box	50000 PCS	
	QFN16L		3000/reel	30000/box	120000 PCS	
VK36N8I	SOP16	50/tube		5000/box	50000 PCS	
	QFN16L		3000/reel	30000/box	120000 PCS	
VK36N9I	SOP16	50/tube		5000/box	50000 PCS	
	QFN16L		3000/reel	30000/box	120000 PCS	
VK36N10I	SOP16	50/tube		5000/box	50000 PCS	
	QFN16L		3000/reel	30000/box	120000 PCS	

## 5 Package Pinout Information(SOP16/QFN16L)



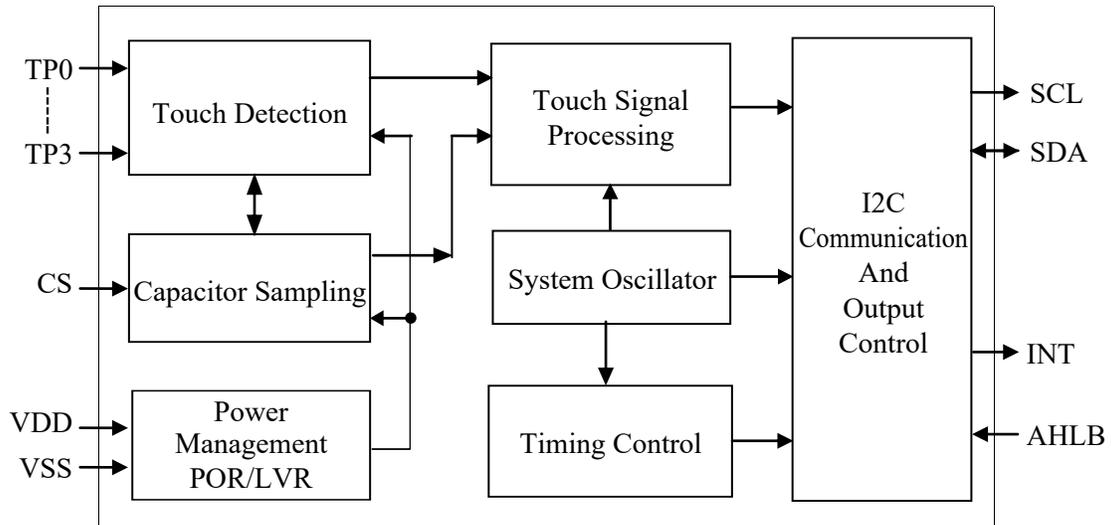
For more information: Page 13-14

## 5.1 VK36N4I/SOP16/QFN16L Pin Description

Pin Names		I/O	Function Description
SOP16	QFN16L		
1-NC	3-NC	—	---
2-NC	4-NC	—	---
3-TP3	5-TP3	I	Touch input: Connect a small capacitor to ground to fine-tune the sensitivity (1-50pF), and it is most sensitive when not connected
4-TP2	6-TP2	I	Touch input: Connect a small capacitor to ground to fine-tune the sensitivity (1-50pF), and it is most sensitive when not connected
5-TP1	7-TP1	I	Touch input: Connect a small capacitor to ground to fine-tune the sensitivity (1-50pF), and it is most sensitive when not connected
6-TP0	8-TP0	I	Touch input: Connect a small capacitor to ground to fine-tune the sensitivity (1-50pF), and it is most sensitive when not connected
7-CS	9-CS	I	Sensitivity adjustment, connect to ground capacitor (1-47nF)
8-VSS	10-VSS	VSS	Negative power supply
9-AHLB	11-AHLB	I	Select the output level: Open -> low level effective, VSS-> high level effective
10-SCL	12-SCL	I	The I2C serial clock pin requires an external pull-up resistor
11-SDA	13-SDA	I/O	The I2C serial data input/output pins need to be connected to an external pull-up resistor
12-VDD	14-VDD	VDD	Positive power supply
13-INT	15-INT	O	Touch state output and open-drain output require an external pull-up resistor
14-NC	16-NC	—	---
15-NC	1-NC	—	---
16-NC	2-NC	—	---

## 6 Functional Description

### 6.1 Block Diagram



## 6.2 Auto-calibration Function

After power-on, the chip will be initialized to obtain the first reference value. When there is no touch, the touch chip will automatically calibrate the reference value, allowing it to change dynamically according to the external environment.

For example, reliable touch detection can be achieved through this mechanism when there are temperature changes or environmental noise.

## 6.3 Fool-proof function

To minimize the detection of unintentional key presses such as accidentally touching the sensing electrode, the chip is equipped with a maximum key press duration function internally. When a touch key is pressed, the internal timer starts to count. Once the key is pressed for too long, exceeding approximately 13 seconds, the touch chip will ignore the status of the touched key, recalculate it, obtain a new reference value, and simultaneously reset the output status to the initial power-on state.

## 6.4 Resistance to voltage fluctuations

The chip is equipped with an anti-voltage fluctuation function, which can prevent the touch keys from malfunctioning due to the sudden drop in working voltage caused by the large current drive from the outside.

## 6.5 Output Mode

The output of VK36N4I is I2C output +INT interrupt pin. The effective output level can be selected based on the status of the AHLB pin when powered on.

The INT interrupt pin outputs the touch status. When there is a touch, the output level changes; when there is no touch, the output level returns to the power-on state.

AHLB	Select the output effective level
NC	Low level effective, power-on output 1
VSS	High level effective, power-on output 0

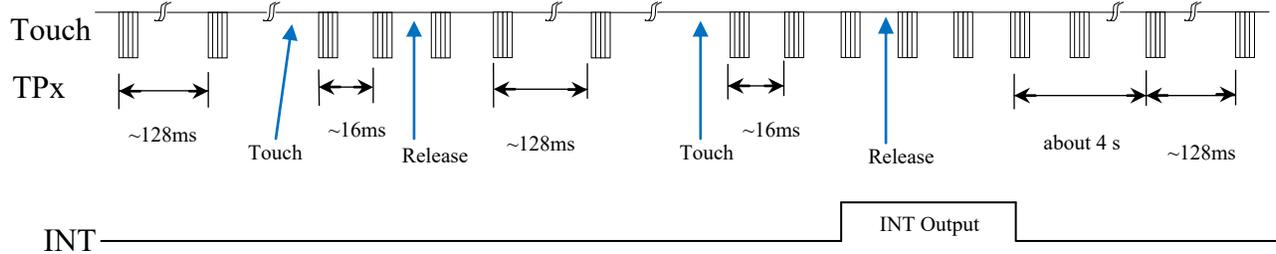
Data format: INT+I2C data key-value.

AHLB is suspended when powered on					
Touch Pin	I2C data corresponds to key values	INT	Touch Pin	I2C data corresponds to key values	INT
	B7 B6 B5 B4 B3 B2 B1 B0			B7 B6 B5 B4 B3 B2 B1 B0	
TP0 Touch	1 1 1 1 1 1 1 0	0	TP0 Release	1 1 1 1 1 1 1 1	1
TP1 Touch	1 1 1 1 1 1 0 1	0	TP1 Release	1 1 1 1 1 1 1 1	1
TP2 Touch	1 1 1 1 1 0 1 1	0	TP2 Release	1 1 1 1 1 1 1 1	1
TP3 Touch	1 1 1 1 0 1 1 1	0	TP3 Release	1 1 1 1 1 1 1 1	1
Note: When powered on, I2C data =1111, 1111, INT output pin level =1					

Powering on, connect AHLB to VSS					
Touch Pin	I2C data corresponds to key values	INT	Touch Pin	I2C data corresponds to key values	INT
	B7 B6 B5 B4 B3 B2 B1 B0			B7 B6 B5 B4 B3 B2 B1 B0	
TP0 Touch	0 0 0 0 0 0 0 1	1	TP0 Release	0 0 0 0 0 0 0 0	0
TP1 Touch	0 0 0 0 0 0 1 0	1	TP1 Release	0 0 0 0 0 0 0 0	0
TP2 Touch	0 0 0 0 0 1 0 0	1	TP2 Release	0 0 0 0 0 0 0 0	0
TP3 Touch	0 0 0 0 1 0 0 0	1	TP3 Release	0 0 0 0 0 0 0 0	0
Note: When powered on, the I2C data =0000, 0000 INT output pin level =0					

## 6.6 Working Mode

The VK36N4I chip has two working modes: standby mode and normal mode. The key was touched and switched to the normal mode. The keyless touch 4S automatically enters standby mode to reduce power consumption. When VDD=5V, the INT output response is approximately 160 milliseconds in standby mode and about 48 milliseconds in working mode.



## 6.7 Sensitivity Adjustment

The sensitivity of VK36N4I is related to the size of the touch PAD, the thickness of the shell, the size of the sensitivity capacitance, etc. The sensitivity should be adjusted according to the actual application of the product. The sensitivity can be adjusted from the following four aspects:

1. Touch the area of the PAD  
Under other unchanged conditions, the larger the touch area, the more sensitive it is, but the area must be within the effective area.
2. The thickness of the shell  
Under other unchanged conditions, the thinner the casing, the higher the sensitivity; the thicker the casing, the lower the sensitivity. However, the thickness must not exceed the maximum limit.
3. Adjust the capacitance value of pin CS to ground  
CS adjusts the overall sensitivity. The larger the value, the more sensitive it is. Commonly used values range from 1 to 47nF, and for some special applications, there are also values exceeding 200nF.
4. Adjust the small capacitance between the touch foot and the ground  
The sensitivity is fine-tuned by touching the small capacitance of the touch foot to the ground. The larger the capacitance, the lower the sensitivity. It is most sensitive without a capacitor. Common values range from 1 to 50pF.

Shell thickness (acrylic or glass)	CS Electrical value (for reference only)
<3mm	6.8nF/25V
3-6mm	10nF/25V
6-10mm	22nF/25V

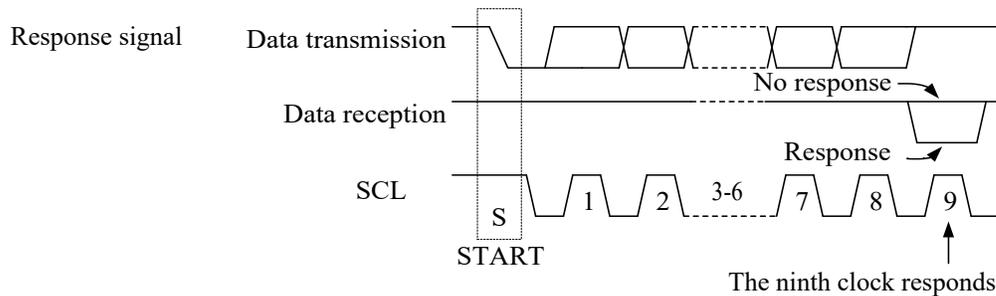
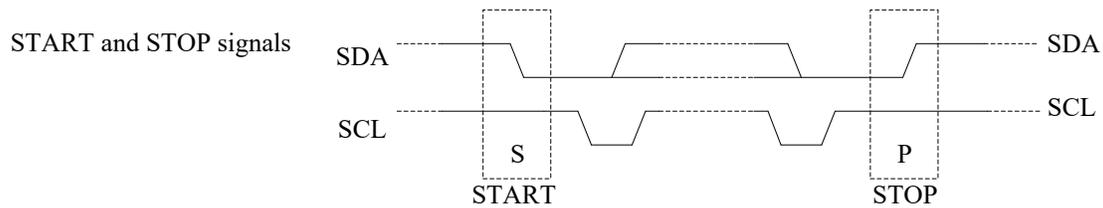
## 7 I2C Communication Interface

The VK36N4I has two communication pins and follows the I2C protocol, with a maximum communication speed of 400kbit/S.

The SCL pin is the clock input pin, and the SDA pin is the serial data input/output pin, which requires an external pull-up resistor.

When the I2C bus is idle, both pins are at a high level. When the SCL signal is at a high level and the SDA signal changes from a high level to a low level, the operation starts or resumes. Conversely, when the SCL signal is at a high level and the SDA signal changes from a low level to a high level, the operation stops.

When the SCL signal is at a high level, the data on the SDA port is all valid and stable. Only when the SCL signal is at a low level can the level on the SDA port be changed.

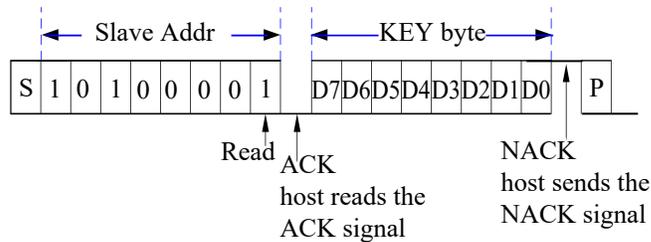


IC address

(0xA1)bit0=1 read bit

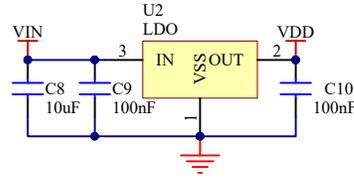
1	0	1	0	0	0	0	0	1
---	---	---	---	---	---	---	---	---

Read a byte of key value:

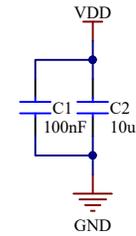


## 8 Application Circuits

It is recommended to use LDO for power supply

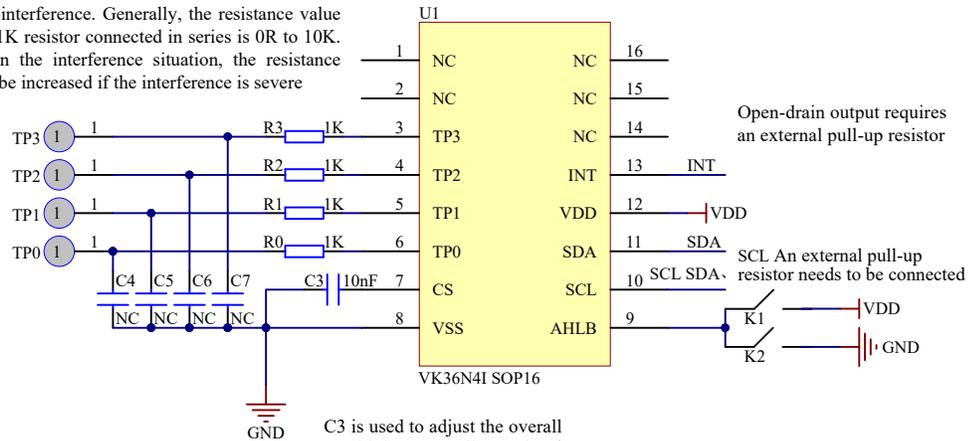


Add a filter capacitor to the power pin to stabilize the power supply



C4-C7 is used to fine-tune the sensitivity of each channel. Generally, the larger the capacitance between 0pF and 50pF, the less sensitive it is. It is most sensitive without soldering

The touch pin is connected in series with a 1K resistor to enhance anti-interference. Generally, the resistance value range of the 1K resistor connected in series is 0R to 10K. Depending on the interference situation, the resistance value should be increased if the interference is severe



C3 is used to adjust the overall sensitivity, generally ranging from 1nF to 47nF; the larger it is, the more sensitive it is

Open-drain output requires an external pull-up resistor

SCL An external pull-up resistor needs to be connected

**AHLE**

**VDD** Low level is valid. Power-on output is 1.

**GND** High level is valid. Power-on output is 0.

## 9 Electrical Characteristics

### Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Power Voltage	VDD	-0.3~6.0	V
Input Voltage	V <sub>IN</sub>	GND-0.3~VDD+0.3	V
Storage Temperature	T <sub>STG</sub>	-50~+125	°C
Operating Temperature	T <sub>OTG</sub>	-40~+85	°C
Human Body Mode	ESD	4KV-8KV(Class 3A)	KV

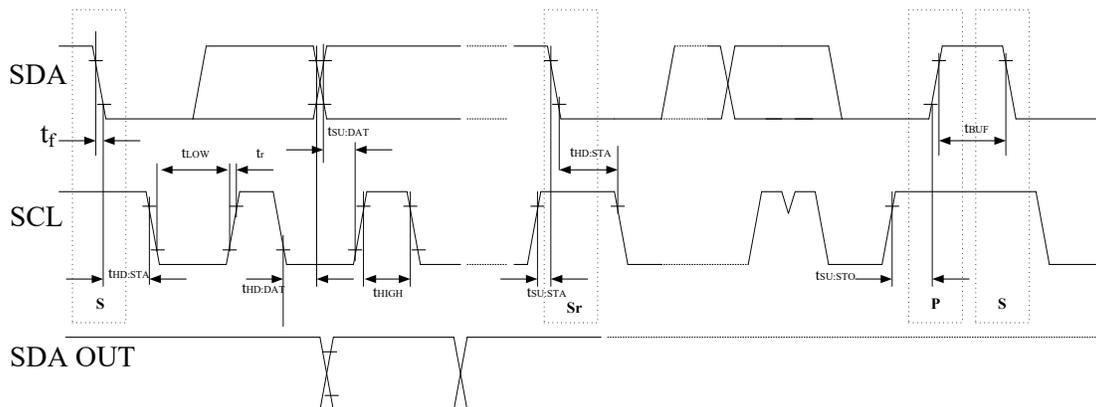
### 9.1 DC Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions (25 °C)	
						VDD	Conditions
Operating voltage	VDD	2.2	3.0	5.5	V	—	—
Low-voltage reset	LVR	—	2.3	2.1	V	—	—
Operating current	I <sub>OP</sub>	—	1.3	—	mA	3.0V	CS=10nF
		—	2.2	—		5.0V	
Standby current	I <sub>ST</sub>	—	10	—	μA	3.0V	CS=10nF
		—	33	—		5.0V	
Output sink current	I <sub>IL</sub>	—	4	—	mA	3.0V	V <sub>OL</sub> =0.6V
		—	8	—		5.0V	
Output source current	I <sub>OL</sub>	—	-2	—	mA	3.0V	V <sub>OH</sub> =2.6V
		—	-4	—		5.0V	V <sub>OH</sub> =4.3V
Input low voltage	V <sub>IL</sub>	—	—	0.3	VDD	VDD	Input low voltage
Input high voltage	V <sub>IH</sub>	0.7	—	1	VDD	VDD	Input high voltage
Input the pull-up resistor	R <sub>PH</sub>	—	150k	—	ohm	3.0V	VDD=3V
Input the pull-down resistor	R <sub>PL</sub>	—	50k	—	ohm	3.0V	VDD=3V
Output response time	T <sub>R</sub>	—	45	—	mS	3.0V	Normal mode
		—	48	—		5.0V	Normal mode
		—	150	—	mS	3.0V	Standby mode
		—	160	—		5.0V	Standby mode

## 9.2 AC Electrical Characteristics

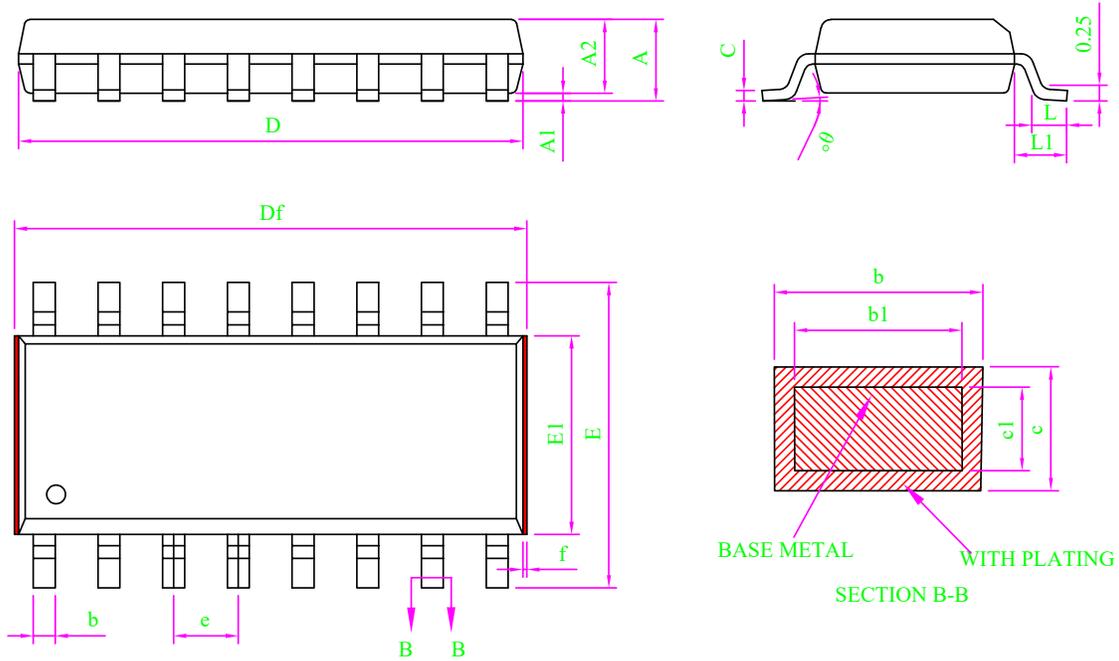
Symbol	Parameter	Min.	Max.	Unit	Test Conditions
					Conditions
$f_{SCL}$	Clock frequency	—	400	kHZ	—
$t_{BUF}$	Bus idle time	1.3	—	$\mu s$	During this period, the bus must remain idle until a new transmission begins
$t_{HD; STA}$	Start-up condition holding time	0.6	—	$\mu s$	After this period, the first clock pulse will be generated
$t_{LOW}$	SCL low-level time	1.3	—	$\mu s$	—
$t_{HIGH}$	SCL high-level time	0.6	—	$\mu s$	—
$t_{SU; STA}$	Set the time in the "Start" state	0.6	—	$\mu s$	It is only related to the repeated START signal
$t_{HD; DAT}$	Data retention time	0	—	$\mu s$	—
$t_{SU; DAT}$	Data setting time	100	—	ns	—
$t_r$	Rising time	—	0.3	$\mu s$	Periodic sampling
$t_f$	Decrease time	—	0.3	$\mu s$	Periodic sampling
$t_{SU; STO}$	Stop setting the time for the condition	0.6	—	$\mu s$	—
$t_{AA}$	The effective clock output time	—	0.9	$\mu s$	—
$t_{SP}$	Input filter time constant (SDA and SCL pins)	—	50	ns	Noise suppression time

### I<sup>2</sup>C timing



## 10 Package Information

### 10.1 SOP16(9.9mm x 3.9mm PP=1.27mm)

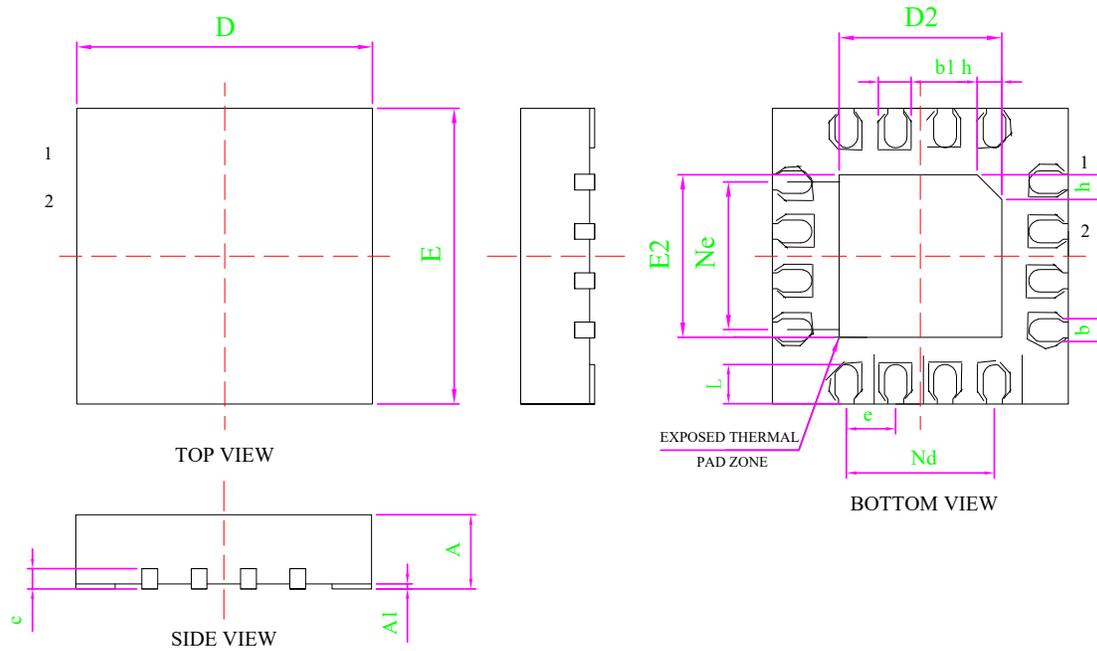


Note:

- All dimension are in mm.  
Dim D&E1 does not include plastic flash; Df includes plastic flash(f);  
Flash: Plastic residual around body edge after de junk/singulation.
- Dim b does not include dambar protrusion/intrusion.
- Plating thickness 0.007mm-0.020mm

MILLIMETER			
SYMBOL	MIN	NOM	MAX
A	-	-	1.75
A1	0.10	0.15	0.20
A2	1.35	1.45	1.55
b	0.39	-	0.47
b1	0.38	0.41	0.43
c	0.20	-	0.25
c1	0.19	0.20	0.21
D	9.80	9.90	10.00
Df	9.90	-	10.40
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e	1.27BSC		
L	0.51	0.66	0.81
L1	0.95	1.05	1.15
θ	0	-	8°
f	0.05	-	0.20

## 10.2 QFN16L(3.0mm × 3.0mm PP=0.5mm)



Dimensions			
SYMBOL	MIN	NOMINAL	MAX
A	0.70	0.75	0.80
A1	0	0.02	0.05
b	0.18	0.25	0.30
b1	0.30	0.35	0.40
c	0.18	0.20	0.25
D	2.90	3.00	3.10
D2	1.55	1.65	1.75
e	0.50BSC		
Ne	1.50BSC		
Nd	1.50BSC		
E	2.90	3.00	3.10
E2	1.55	1.65	1.75
L	0.35	0.40	0.45
h	0.20	0.25	0.30
L/F carrier size (miL)	75*75		

## 11 Disclaimer

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## 12 Revision History

No.	Version	Date	Modify the content	Check
1	1.0	2018-08-10	Original version	YES
2	1.1	2020-02-11	Add reference circuit	YES
3	1.2	2025-12-27	Update version	YES

[1] Consult the recently published documents before starting or finishing the design.

[2] Since the release of this document , the device product status described in this document may have changed and may differ in several cases. The latest product status information can be found on the Internet at <https://www.szvinka.com/>